Nanostructured surface fabricated by laser interference lithography to attenuate the reflectivity of microlens arrays

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A subwavelength-scale square lattice optical nanostructure is fabricated using an interference photolithography process on the surface of a quartz microlens array. This nanostructuring of the quartz surface introduces an antireflective effect, reducing reflectivity between 10% and 30% and enhancing the transmissivity 3% in the visible spectrum. This approach permits fast fabrication on a 4-inch wafer covered with microlenses (non-flat surface) and produces monolithic devices which are robust to adverse environments such as temperature variations. [DOI: 10.2971/jeos.2010.10006]

Keywords: antireflective, nanostructure, microlens, interference photolithography

1 INTRODUCTION

Fabrication of microlens arrays has been extensively explored [1]–[3] as they are widely used in a large range of applications, often to link between macro and micro optical components [4]. Antireflective (AR) coatings and surface treatments on microlenses have been proposed for different materials and wavelengths [5]–[7] and theoretical analyses have been performed [8]. The principal solution proposed in a number of papers consists of an antireflective coating deposited on the structure. Although this method is quite evolved, there are some applications where having a monolithic material structure is advantageous, such as in extreme temperature conditions or particularly aggressive environments, as presented in [9] for planar surfaces. Gratings on microlenses in plastic materials have been demonstrated using replication by hot embossing [10].

In this paper, we investigate an alternative approach. It consists of nanostructuring the surface of the microlenses, producing an AR layer having engineered effective refractive index properties which reduces the reflectivity and enhances the light transmission through the lens. In this work we demonstrate the feasibility of fabricating such nanostructures on a large, non-flat surface. In the following, we will present experimental results on such nanostructured monolithic lenses, which, although not ideal, exhibit significant AR characteristics.

2 FABRICATION

To begin, we describe the fabrication of a subwavelength AR layer on the surface of a quartz microlens array with interference photolithography and plasma etching. The challenge is to obtain an homogeneous structure on the entire surface of each lens and on a large array of microlenses. The shape of the nanostructures we produce with this method is not as rectangular as the structures often studied. However, these more rounded, non-rectangular nanostructures still possess significant AR properties. Moreover, it allows the production of nanostructures quickly, inexpensively, and on large areas.

First, an hexagonal array of 145 μm diameter microlenses is structured by photolithography and a reflow process [11] on a 4-inch quartz wafer. Then, the microlenses, which are 14 μm high, are transferred into the quartz by Reactive Ion Etching (RIE). The pressure is set at 2.7 mbar and the flow rate is set at 3 sccm (standard cubic centimeters per minute) of Ar, 20 sccm of O₂ and 34 sccm of C₃F₈ for an etching rate of approximately 300 nm per minute.
FIG. 1 Side view of a microlens with nanostructured photoresist shows that photoresist covers the entire surface of the microlenses, with varying thickness depending on the position and on the local slope.

For the AR nanostructured surface, a 400 nm diluted photore sist (PR) is spun at very low speed (400 rpm) for 25 seconds, in order to cover fully the surface of the microlenses. The Scanning Electron Microscope (SEM) picture shown in Figure 1 presents a side view of a microlens coated by the nanostructured PR. One can see that due to the slope induced by the microlens’ curvature, the height of the photoresist coating is not uniform over the entire surface [12]. Indeed, the PR thickness varies between the lower (∼1 μm) and the upper (∼450 nm) parts of the microlenses with a minimum around 200 nm where the slope is greatest. This requires that the exposure parameters for the photolithography be set for the thinnest part of the resist in order to avoid overexposure.

After a prebake at 40°C and 50°C for thirty minutes each, the nanostructure pattern is introduced by interference photolithography [13]. A UV laser beam (Kr 2+) is expanded and spatially filtered passing through a microscope objective (20×) and a 10 μm pinhole to create a coherent spherical wavefront (see Figure 2), which can be approximated in the far field as a planar wavefront for a small area. The fringes are created by placing a mirror at 90° with respect to the sample (Lloyd’s mirror configuration). The grating period, Λ, is selected by adjusting the angle, θ, between the two incident beams using the x-y rotational stage following the equation $\Lambda = \lambda / \sin \theta$, where the laser wavelength, $\lambda$, is fixed at 413 nm [14]. Then the wafer is rotated in the y-z plane by 90° and exposed again to obtain a two dimensional square lattice.

The power on the sample is set at 1 μW/cm² and the total exposure time is approximately one minute.

After a post baking process at 80°C, the last step is to transfer the nanostructures from the resist into the quartz. This is achieved using a short plasma etch (30 sccm C₃F₈ + 1 sccm Ar). The maximum thickness of quartz removed in this step is 200 nm, so the shape of the microlenses is only minimally affected. After removing the photoresist, we obtain a 4-inch wafer covered with microlenses having a nanostructured AR surface in quartz.

Figure 3 shows SEM pictures of a nanostructured microlens (see Figure 3(a)) and close-up views of the shape of the nanostructures on different areas of the lens (see Figures 3(b), 3(c) and 3(d)).

The annular rings (Moiré effect) observed in the SEM picture in Figure 3(a) show that the nanostructures completely cover the non-flat surface consisting of microlenses. The periodicity is 270 nm in both transverse directions, independent of the position on the lens.

The nanostructures in the central region of the lens (see Figure 3(b)) are approximately 100 nm deep, and have a slightly rounded shape as compared to the rectangle structures studied theoretically [5]. In addition, one can observe some links between the pillars. In the maximum slope region (see Figure 3(c)), we can see that the links between the pillars have disappeared, and the structures are approximately 40 nm deep. In the edge region of the lens (see Figure 3(d)), the shape of the nanostructures have the same profile as in the central region (see Figure 3(b)). The variations in the aspect ratio of the nanostructures are due to the inhomogeneity of the PR thickness as shown in Figure 1.
FIG. 4 Measured phase image of a nanostructured microlens using an interference microscope, working at 632 nm wavelength, to characterize the Strehl ratio.

Note that the non-rectangular nanostructure profile does not, a priori, impact the desired properties of our device, as our goal is not to obtain a wavelength filter but rather a broadband AR effect. An optimization of the PR deposition process shall be envisaged to improve the homogeneity. Nevertheless, as we will demonstrate, these nanostructures result in a significant reduction in the reflectivity of the microlens surface.

The quality of the microlenses is measured using a Mach-Zehnder interferometric microscope, using an iris to select a single lens [15]. The phase and intensity of the interference pattern are measured, then the Strehl ratio of the lenses is calculated. The Strehl ratio is the ratio between the peak diffraction intensities of an aberrated versus a perfect wavefront. Conventionally, the acceptable value for the Strehl ratio is greater than 0.8, which corresponds to an rms wavefront error of λ/14 (Marechal’s criterion [16]). For the quartz microlenses without nanostructure, we obtain Strehl ratios between 0.92 and 0.99 depending on the specific lens selected. After the plasma etching, due to the PR thickness variation, the shape of the microlenses changes slightly and the Strehl ratio is measured to be around 0.9. The measurements are done on different areas of two wafers of each type. From the phase image shown in Figure 4, we observe that the aberrations come mostly from the outer part of the lens.

From these measurements, we demonstrate the feasibility of producing a nanostructured AR surface on a quartz microlens array without significantly reducing the quality of the lenses. Indeed, the challenge here is to fabricate a combination of micro- and nano-scale structures on a large surface in the same material.

3 CHARACTERIZATION IN REFLECTION

In the previous section, we demonstrated the production of a microlens array with its entire surface covered by a nanostructured AR square grating. However, the fabricated nanostructures were non-ideal in several respects, including variability in the nanostructure size depending on the position on the lens, and deviation of the pillar shape from the rectangular profile of the original design [5]. In this section, we will show through experimental characterization that these non-ideal nanostructures still provide a significant attenuation of the reflectivity of the microlens array.

The setup used for the reflection measurements is shown schematically in Figure 5. It is based on a standard microscope stand (Leica DMR) with a spectrometer (Ocean Optics 2000) mounted at the end of the light path. Three objectives have been used: 100× (NA = 0.9), 40× (NA = 0.6) and 20× (NA = 0.4). An adjustable circular diaphragm is added in the light path to be imaged onto the sample. It allows control of the spot size to be measured. This setup will be used for all reflection measurements of our samples.

The first step is to characterize the performance of the nanostructured AR surface on a flat substrate. A flat quartz wafer without nanostructures is measured to obtain a reference signal \( R_{\text{ref}} \) with the image of the diaphragm is set at 140 μm diameter. Then, the reflection of the nanostructured sample is measured \( R \) with the same parameters of illumination and detection. The graph shown in Figure 6 shows the ratio between the spectral response of the nanostructured surface and the reference signal. The red curve is the result using a 100× objective with a numerical aperture of 0.9 and the black curve using a 40× objective with a numerical aperture of 0.6. The reflectivity is decreased between 10 and 35% with the 100× objective and between 5 and 10% with the 40× objective. This means that the nanostructure layer has an antireflective effect over the entire visible wavelength range, as was predicted theoretically and already demonstrated experimentally with other materials [5].

Furthermore, using a higher numerical aperture (i.e. a larger
The illumination angle reduces the reflectivity, which qualitatively agrees with the theoretical predictions presented in Table 2 of [5].

The reflectivity varies as a function of the wavelength, as demonstrated in [17]. In the results shown in Figure 6, the largest attenuation is obtained for smaller wavelengths. Theoretically, the minimum of reflection should be centered around 550 nm. However, since the height of the nanopillars is lower than in the design, it is to be expected that this minimum is shifted to lower wavelengths.

Moreover, measurements are made on different areas of the sample with essentially identical results (less than 5% variation). This shows that the nanostructures are relatively homogenous over the entire 4-inch wafer.

From these results, we have demonstrated that we are able to fabricate a square lattice of nanopillars with a periodicity of 270 nm on a 4-inch wafer. A non-negligible attenuation of the reflectivity has been observed and could be improved by producing taller nanostructures.

The objective is then to determine whether the nanostructures maintain the same AR behavior on a microlens array instead of on a flat surface. The setup shown in Figure 5 is used to characterize these samples. In this case the reference is defined by measuring the reflectivity of an array of quartz microlenses without AR nanostructures, and all the results are normalized by this reference.

Two different studies have been performed. The first consists of the measurement of the reflectivity of a surface containing several nanostructured microlenses (≈7). In this case, a 20x objective with a numerical aperture of 0.4 is needed to image a large enough area (450 μm in diameter). For both the sample and the reference, the center of one microlens is positioned in the middle of the light path. The results are shown in Figure 7.

The attenuation of the reflectivity is between 30% and 15% over the visible spectrum. The curve shown is an average of two measurements acquired on two different areas of the sample.

The second experiment measures the behavior of a single microlens. In this case, a 100x objective is aligned with the center of one microlens. Diaphragms with different aperture diameters are used to observe the effect of the curvature of the microlens on the AR properties. The normalized reflectivity measurements are plotted in Figure 8 for image diameters of 47 μm, 93 μm, 117 μm and 140 μm. The largest aperture corresponds to nearly an entire microlens. Each curve is the average of three measurements performed on different areas of the wafer. Note that the reference is always measured with the same diaphragm size as the sample.

The curves in Figure 8 show that better attenuation, between
Comparing Figures 6 and 8, one can see that the attenuation of the reflectivity is better (by roughly a factor of two) for the flat nanostructures than for the microlenses. This can be explained by the variation of the nanopillar’s height as a function of their position on the microlens, as shown in Figure 3. An improvement of the fabrication process is necessary in order to produce a more homogeneous layer of photoresist [12].

Antireflective properties have been observed on nanostructured flat surfaces (see Figure 6) as well as on single microlenses (see Figure 8) and an area composed of several microlenses (see Figure 7). In this last case the attenuation of the reflectivity is greater than for the single lens, which shows that the flat area between the microlenses also contributes to this effect.

4 TRANSMISSION CHARACTERIZATION

In most cases, microlenses are used in transmission to focus light (e.g. onto a sensor array). To complete the study of our device, transmission measurements are performed.

The experimental setup used for transmission measurements is shown in Figure 9. Due to technical issues, the sample must be illuminated from backside. In order to focus light on the side of the wafer with the structure, a condenser with a numerical aperture of $\text{NA} = 0.6$ is used. Light is collected by a microscope objective (100×) and analyzed using a spectrometer.

Once again, the reference for the experimental measurements is a microlens without nanostructures. The normalized transmissivity curve shown in Figure 10 is the smoothed mean of three measurements taken on different areas of the wafer. The enhancement of the transmissivity over the visible range is 3% on average. For comparison, the maximum expected transmissivity of this device has been calculated using ray tracing simulation software FRED from Photon Engineering, (applying the Fresnel equations at the interfaces). By evaluating a microlens without nanostructures with the same illumination and collection microscope objectives (numerical apertures are taken into account) as in the experiment, we estimate the maximum transmission enhancement to be 5% according to this model.

As in the reflectivity measurements, the fabricated non-ideal nanostructures still show significant AR properties, increasing the transmissivity of the microlenses by an average of 3% across the visible spectrum. This improvement is also an appreciable fraction of the theoretical maximum enhancement of 5%.

FIG. 9 Setup for transmission measurements of microlenses with and without AR nanostructures.

20% and 11%, is obtained when nearly the entire microlens is considered.

FIG. 10 The red curve shows the ratio between the transmitted light through quartz microlens with and without AR nanostructures while the black curve shows the maximum potential transmittance.
icates that the AR nanostructure is not materially damaged by this temperature cycling. The black and red curves represent the measurements performed before and after heating respectively normalized by a reference (microlenses without nanostructures). Each curve is the average of two measurements performed on different areas of the wafer.

The durability of the AR nanostructure with respect to temperature cycling is not surprising, as the only material in the device is quartz. Moreover, as these structures are composed of a monolithic, homogenous material, they may better tolerate adverse environments, including extreme temperatures, variable humidity, immersion in liquids, or caustic surroundings. This suggests an important potential of applications for single-material microlenses with an AR surface.

6 CONCLUSION

In this paper, the feasibility of fabricating an anti-reflective layer by nanostructuring large microlens arrays (4-inch wafer) has been demonstrated. The reduced reflectivity of the microlens surface is based on the engineered effective refractive index properties of a nanostructure, in this case an array of pillars that covers the entire surface of the microlenses. Although the structures on quartz microlens arrays are not perfect, the reflectivity measurements show a 15% improvement compared to unstructured microlenses. Transmission measurements, obtained with a different setup, show an enhancement of approximately 3% of the transmission. Incremental improvements in the fabrication process can further improve the performance of the antireflective surface, facilitating their incorporation into more complex micro-optical systems. An antireflective treatment of the backside of the wafer, either through nanostructuring or other methods, could also be envisaged.

In addition, we have demonstrated the interference lithography technique as a suitable method for the delicate fabrication of a nanostructure on a large, non-flat surface. This work has shown promising results consistent with theoretical predictions.

Finally, we have shown that a single-material device is stable and robust, for example to variations in temperature, which suggests that these devices may be suitable for applications involving extreme environmental conditions.

References